

30A, 45V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Low voltage, high freq. inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

- Case: TO-263AB (D²PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.40g (approximately)

| KEY PARAMETERS | | | |
|--------------------|-------------------------------|------|--|
| PARAMETER | VALUE | UNIT | |
| I _F | 30 | Α | |
| V_{RRM} | 45 | V | |
| I _{FSM} | 220 | Α | |
| T _{J MAX} | 150 °C | | |
| Package | TO-263AB (D ² PAK) | | |
| Configuration | Dual dies | | |

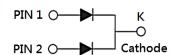








TO-263AB (D²PAK)



| PARAMETER | SYMBOL | MBRS3045CTH | UNIT |
|--|------------------|-------------|------|
| Marking code on the device | | MBRS3045CT | |
| Repetitive peak reverse voltage | V_{RRM} | 45 | V |
| Reverse voltage, total rms value | $V_{R(RMS)}$ | 31 | V |
| Forward current | I _F | 30 | А |
| Surge peak forward current, 8.3ms single half sine wave superimposed on rated load | I _{FSM} | 220 | А |
| Critical rate of rise of off-state voltage | dv/dt | 10,000 | V/µs |
| Junction temperature | TJ | -55 to +150 | °C |
| Storage temperature | T _{STG} | -55 to +150 | °C |

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| THERMAL PERFORMANCE | | | |
|--|------------------|-----|------|
| PARAMETER | SYMBOL | TYP | UNIT |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 50 | °C/W |
| Junction-to-case thermal resistance | R _{eJC} | 1.5 | °C/W |

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | |
|--|--|----------------|-----|------|------|
| PARAMETER | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
| Forward voltage per diode (1) | I _F = 15A, T _J = 25°C | V _F | - | 0.70 | V |
| | $I_F = 30A, T_J = 25^{\circ}C$ | | - | 0.90 | V |
| | I _F = 15A, T _J = 125°C | | - | 0.60 | V |
| | $I_F = 30A, T_J = 125^{\circ}C$ | | - | 0.75 | V |
| Reverse current @ rated V _R per diode (2) | T _J = 25°C | I _R | - | 200 | μA |
| | T _J = 125°C | | - | 15 | mA |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | | |
|----------------------|-------------------------------|-------------------|--|
| ORDERING CODE | PACKAGE | PACKING | |
| MBRS3045CTH | TO-263AB (D ² PAK) | 800 / Tape & Reel | |



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

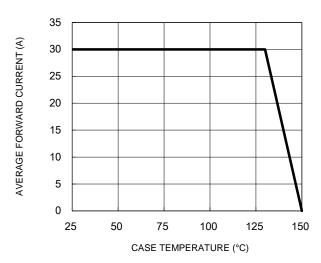


Fig.3 Typical Reverse Characteristics

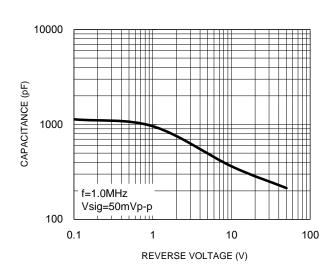
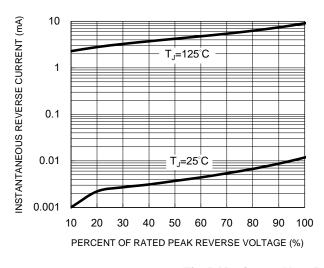


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



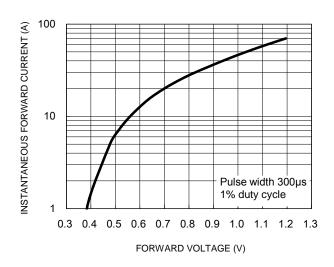
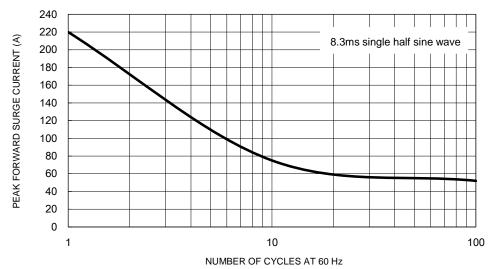


Fig.5 Maximum Non-Repetitive Forward Surge Current



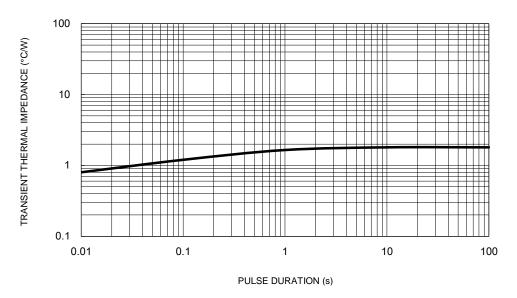
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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

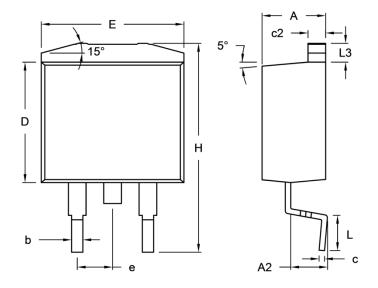
Fig.6 Typical Transient Thermal Impedance





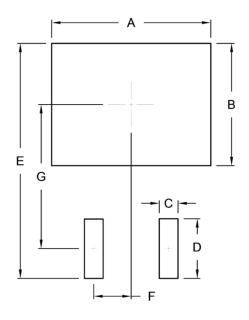
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



| DIM | OIM. Unit (mm) Min. Max. | | Unit (| (inch) | |
|------|--------------------------|-------|--------|--------|--|
| DIM. | | | Min. | Max. | |
| Α | 4.44 | 4.70 | 0.175 | 0.185 | |
| A2 | 2.03 | 2.79 | 0.080 | 0.110 | |
| b | 0.68 | 0.94 | 0.027 | 0.037 | |
| С | 0.36 | 0.53 | 0.014 | 0.021 | |
| c2 | 1.14 | 1.40 | 0.045 | 0.055 | |
| D | 8.25 | 9.25 | 0.325 | 0.364 | |
| E | - | 10.50 | - | 0.413 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| Н | 14.60 | 15.88 | 0.575 | 0.625 | |
| L | 2.29 | 2.79 | 0.090 | 0.110 | |
| L3 | 1.14 | 1.40 | 0.045 | 0.055 | |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α | 10.80 | 0.425 |
| В | 8.30 | 0.327 |
| С | 1.27 | 0.050 |
| D | 4.05 | 0.159 |
| E | 15.95 | 0.628 |
| F | 2.54 | 0.100 |
| G | 9.775 | 0.385 |

MARKING DIAGRAM



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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